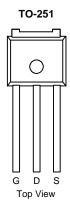


FU9024-VB Datasheet

P-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| - 60 | 0.066 at V _{GS} = - 10 V | - 20 | 40 nC | | | |
| - 00 | 0.080 at V _{GS} = - 4.5 V | - 18 | 40110 | | | |



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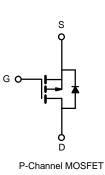
FEATURES

- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

· Load Switch





| Parameter | Symbol | Limit | Unit | | |
|---|------------------------|-----------------------------------|--------------------|-----|--|
| Drain-Source Voltage | | V _{DS} | - 60 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | | |
| | T _C = 25 °C | | - 20 ^a | A | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | | - 16 | | |
| $Continuous Drain Current (T_j = 150 C)$ | T _A = 25 °C | I _D | - 11 ^b | | |
| | T _A = 70 °C | | - 9 ^b | | |
| Pulsed Drain Current | I _{DM} | - 100 | - | | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | - 35 | | |
| Single Pulse Avalanche Energy | L = 0.1 min | E _{AS} | 101 | mJ | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | L. | - 29 ^a | A | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | - 2.1 ^b | — A | |
| | T _C = 25 °C | | 35 ^a | w | |
| Maximum Dawar Dissinction | T _C = 70 °C | P _D | 20 ^a | | |
| Maximum Power Dissipation | T _A = 25 °C | | 3.0 ^b | | |
| | T _A = 70 °C | | 2 ^b | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 33 | 40 | °C/W | | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.98 | 1.2 | C/W | | |

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

- - - - -

b. Surface mounted on 1" x 1" FR4 board.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|---|-------|-------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \mu A$ | - 60 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μΑ | | 68 | | mV/°0 | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | iD = - 230 μA | | - 5.2 | | mv/ c | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.0 | | - 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| Zara Cata Valtaga Drain Current | lana | $V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 1 | μA | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$ | | | - 10 | | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 120 | | | Α | |
| | _ | V _{GS} = - 10 V, I _D = - 30 A | | 0.066 | | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$ | | 0.080 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 50 A | 20 | | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 1200 | | pF | |
| Output Capacitance | C _{oss} | V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz | | 200 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 150 | | | |
| Tatal Cata Channa | Qg | $V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A | | 40 | | - nC | |
| Total Gate Charge | ů. | | | 38 | | | |
| Gate-Source Charge | Q _{gs} | $V_{\rm DS}$ = - 30 V, $V_{\rm GS}$ = - 4.5 V, $I_{\rm D}$ = - 55 A | | 16 | | | |
| Gate-Drain Charge | Q _{gd} | | | 19 | | | |
| Gate Resistance | Rg | f = 1 MHz | | 5.2 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | t _r | V_{DD} = - 2 V, R_L = 2 Ω | | 7 | 15 | - ns | |
| Turn-Off Delay Time | t _{d(off)} | $I_{D}\cong$ - 10 A, V_{GEN} = - 10 V, R_{g} = 1 Ω | | 70 | 110 | | |
| Fall Time | t _f | | | 40 | 60 | | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | ا _S | T _C = 25 °C | | | - 66 | A | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 150 | | |
| Body Diode Voltage | V _{SD} | I _S = - 30 A | | - 1 | - 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 45 | 68 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | L = 50 A di/dt = 100 A/up T = 25 °C | | 59 | 120 | nC | |
| Reverse Recovery Fall Time | t _a | I _F = - 50 A, di/dt = 100 A/μs, T _J = 25 °C | | 29 | | | |
| Reverse Recovery Rise Time | t _b | | | 16 | | ns | |

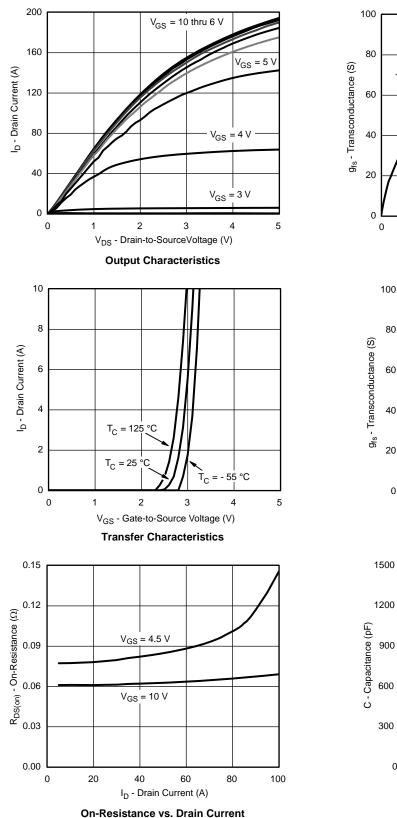
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

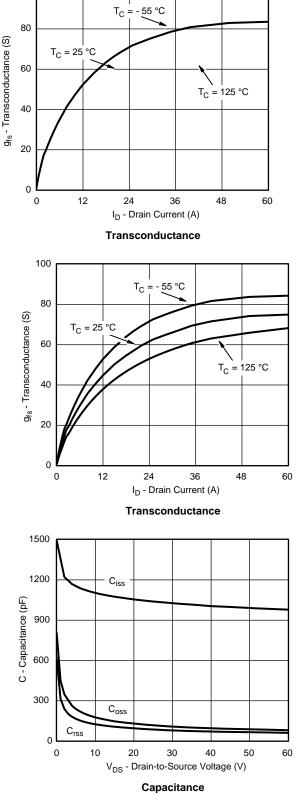
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

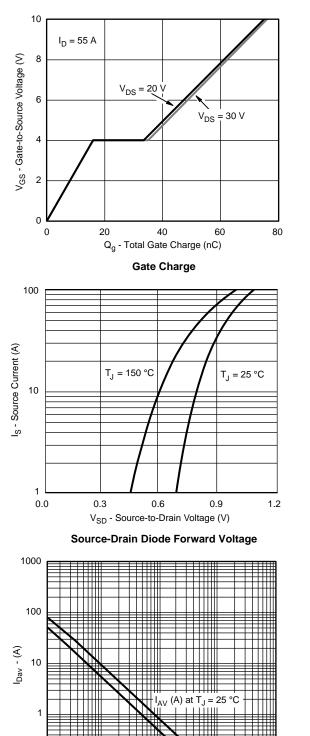




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

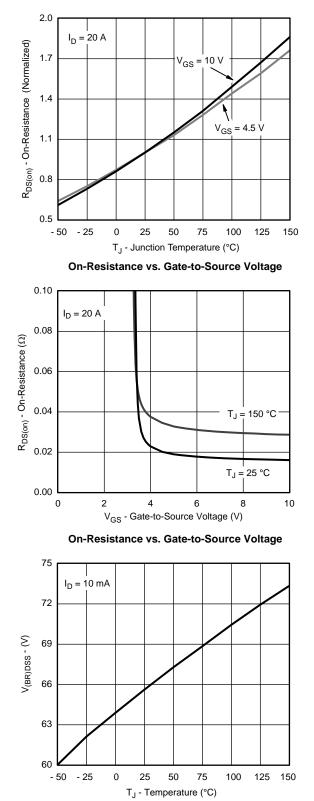
0.1

1

11111

 I_{AV} (A) at T_{J} = 150

0.001

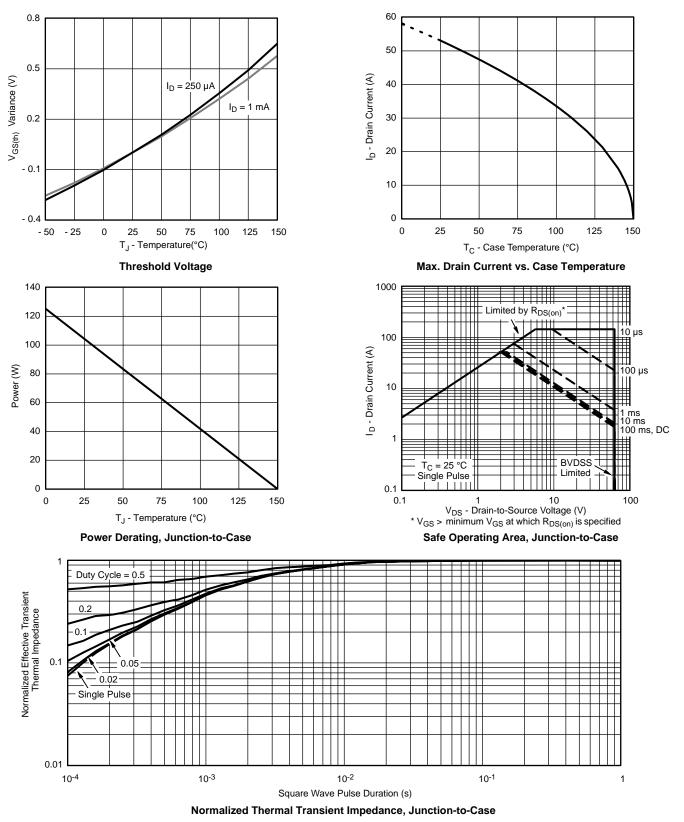


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

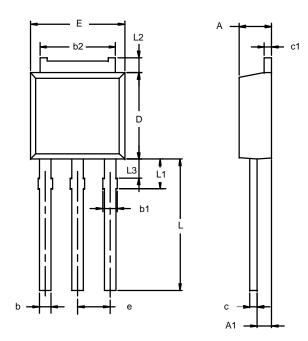




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

| | MILLIN | IETERS | INCHES | | |
|---|----------|--------|-----------|-------|--|
| Dim | Min | Max | Min | Max | |
| Α | 2.21 | 2.38 | 0.087 | 0.094 | |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | |
| b | 0.71 | 0.89 | 0.028 | 0.035 | |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 | |
| С | 0.46 | 0.58 | 0.018 | 0.023 | |
| c1 | 0.46 | 0.58 | 0.018 | 0.023 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| Е | 6.48 | 6.73 | 0.255 | 0.265 | |
| е | 2.28 BSC | | 0.090 BSC | | |
| L | 8.89 | 9.53 | 0.350 | 0.375 | |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 | |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 | |
| ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346 | | | | | |



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